5V/2.1A 150KHz 45V Buck DC to DC Converter For USB Interface XL2011

Features

- Wide 8V to 45V input voltage range
- Fixed 5V output voltage
- Maximum 2.1A output current
- Fixed 150KHz switching frequency
- Internal optimize power MOSFET
- High efficiency up to 92%
- Built in output short shutdown function
- Excellent line and load regulation
- Built in thermal shutdown function
- Built in current limit function
- Available in SOP8 package

Applications

- Car Charger
- Battery Charger
- USB Power Supply

General Description

The XL2011 is a 150 KHz fixed frequency PWM buck (step-down) DC/DC converter, capable of driving a 2.1A load with high efficiency, low ripple and excellent line and load regulation. Requiring a minimum number of external components, the regulator is simple to use and include internal frequency compensation and a fixed-frequency oscillator.

The XL2011 built in output short protection function. When short protection function happens, the chip will be shutdown. An internal compensation block is built in to minimize external component count.

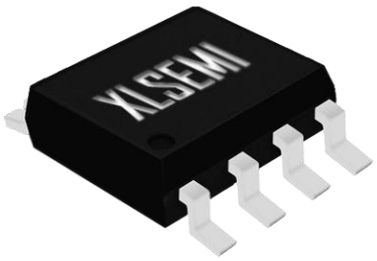


Figure1. Package Type of XL2011

Pin Configurations

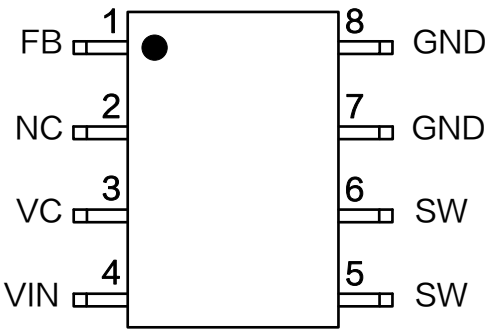


Figure2. Pin Configuration of XL2011 (Top View)

Table 1 Pin Description

Pin Number	Pin Name	Description
1	FB	Feedback Pin (FB). The feedback threshold voltage is 5V.
2	NC	No Connected.
3	VC	Internal Voltage Regulator Bypass Capacitor Pin (VC). The VC pin connect a 1uf capacitor to VIN.
4	VIN	Supply Voltage Input Pin. XL2011 operates from 8V to 45V DC voltage. Bypass Vin to GND with a suitably large capacitor to eliminate noise on the input.
5,6	SW	Power Switch Output Pin (SW). SW is the switch node that supplies power to the output.
7,8	GND	Ground Pin. Care must be taken in layout. This pin should be placed outside of the schottky diode to output capacitor ground path to prevent switching current spikes from inducing voltage noise into XL2011.

Function Block

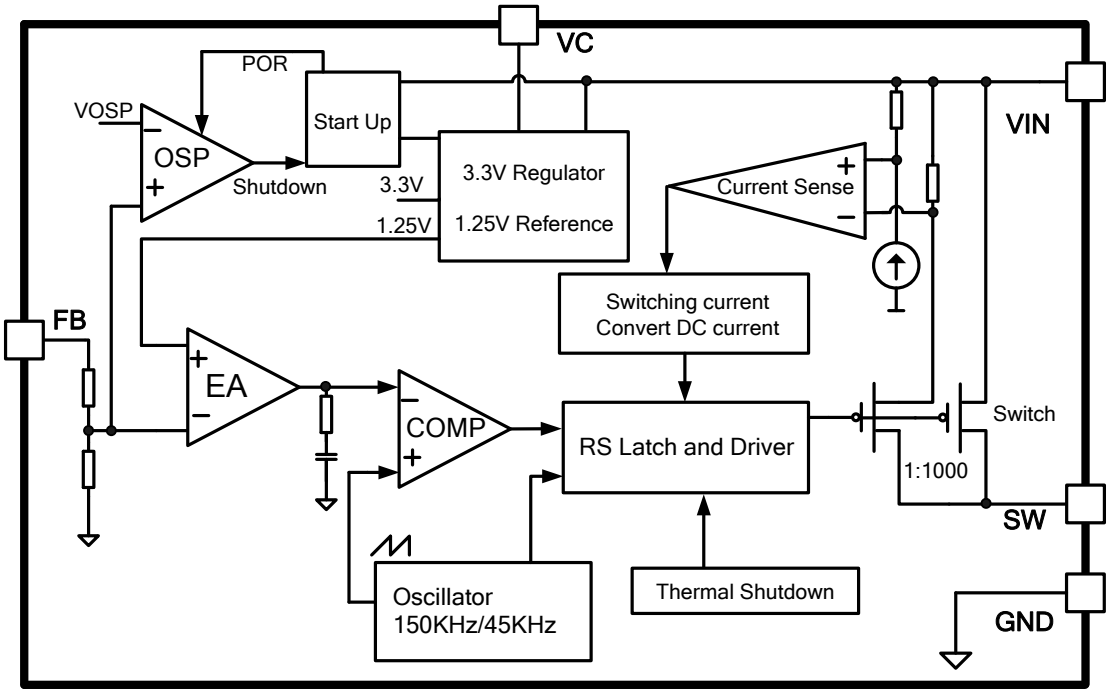


Figure3. Function Block Diagram of XL2011

Typical Application Circuit

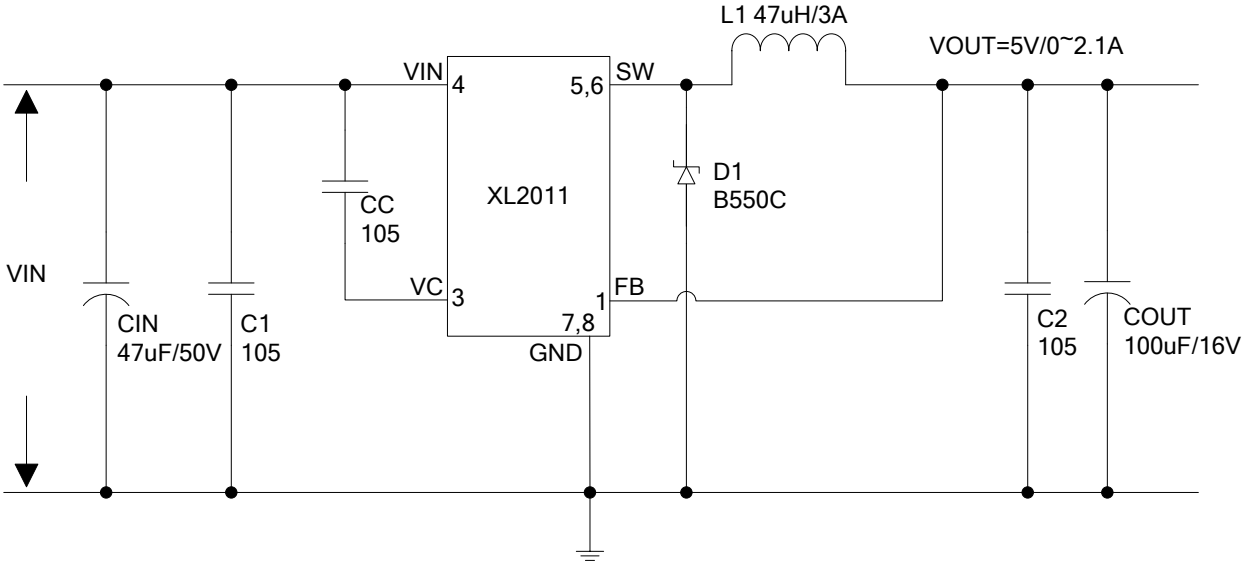


Figure4. XL2011Typical Application Circuit (VIN=8V~45V, VOUT=5V/2.1A)

Ordering Information

Order Information	Marking ID	Package Type	Packing Type Supplied As
XL2011E1	XL2011E1	SOP8	4000 Units on Tape & Reel

XLSEMI Pb-free products, as designated with "E1" suffix in the par number, are RoHS compliant.

Absolute Maximum Ratings (Note1)

Parameter	Symbol	Value	Unit
Input Voltage	Vin	-0.3 to 50	V
Feedback Pin Voltage	V_{FB}	-0.3 to Vin	V
Output Switch Pin Voltage	V_{SW}	-0.3 to Vin	V
Power Dissipation	P_D	Internally limited	mW
Thermal Resistance (SOP8) (Junction to Ambient, No Heatsink, Free Air)	R_{JA}	100	℃/W
Operating Junction Temperature	T_J	-40 to 125	℃
Storage Temperature	T_{STG}	-65 to 150	℃
Lead Temperature (Soldering, 10 sec)	T_{LEAD}	260	℃
ESD (HBM)		>2000	V

Note1: Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

XL2011 Electrical Characteristics

T_a = 25℃;unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
System parameters test circuit figure4						
VFB	Feedback Voltage	Vin = 8V to 45V, Vout=5V Iload=0.5A to 2.1A	4.9	5	5.1	V
η	Efficiency	Vin=12V,Vout=5V Iout=2.1A	–	90	–	%

Electrical Characteristics (DC Parameters)

Vin = 12V, GND=0V, Vin & GND parallel connect a 47uF/50V capacitor; Iout=500mA, T_a = 25℃; the others floating unless otherwise specified.

Parameters	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Input operation voltage	Vin		8		45	V
Quiescent Supply Current	I_q	V_{FB} =Vin		4.7	10	mA
Output Short Supply Current	Iosp				5	mA
Oscillator Frequency	Fosc		128	150	173	KHz
Switch Current Limit	I_L	V_{FB} =0V		2.3		A
Output Power PMOS	Rdson	V_{FB}=0V,Vin=12V, I_{SW}=2A		60	80	mohm

Typical System Application (VOUT=5V/2.1A)

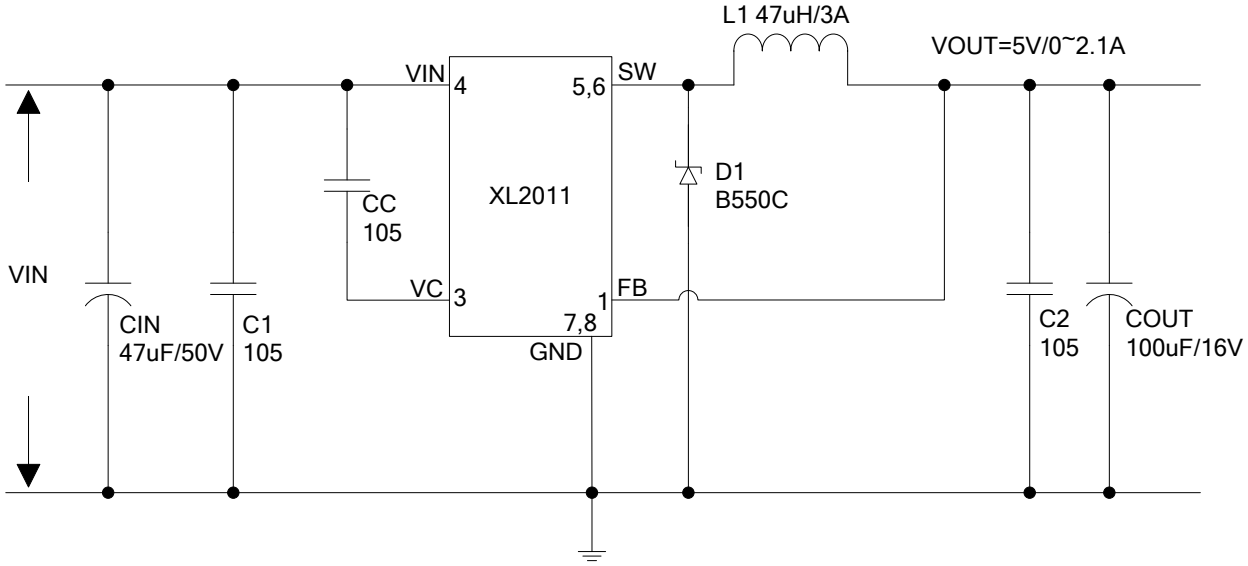


Figure5. XL2011System Parameters Test Circuit (VIN=8V~45V, VOUT=5V/2.1A)

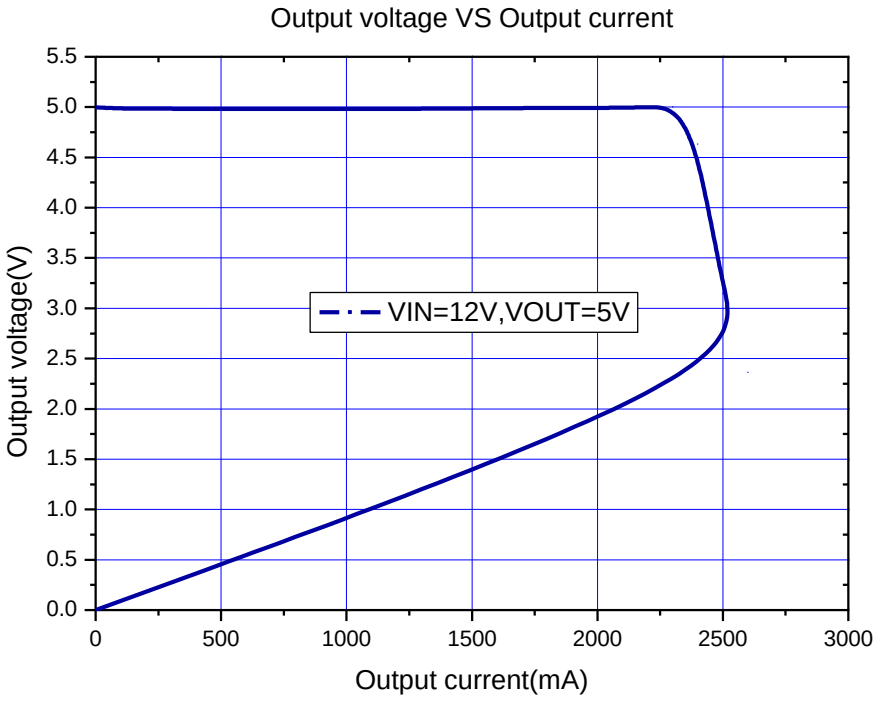


Figure6. XL2011 System Output Constant Current Curve

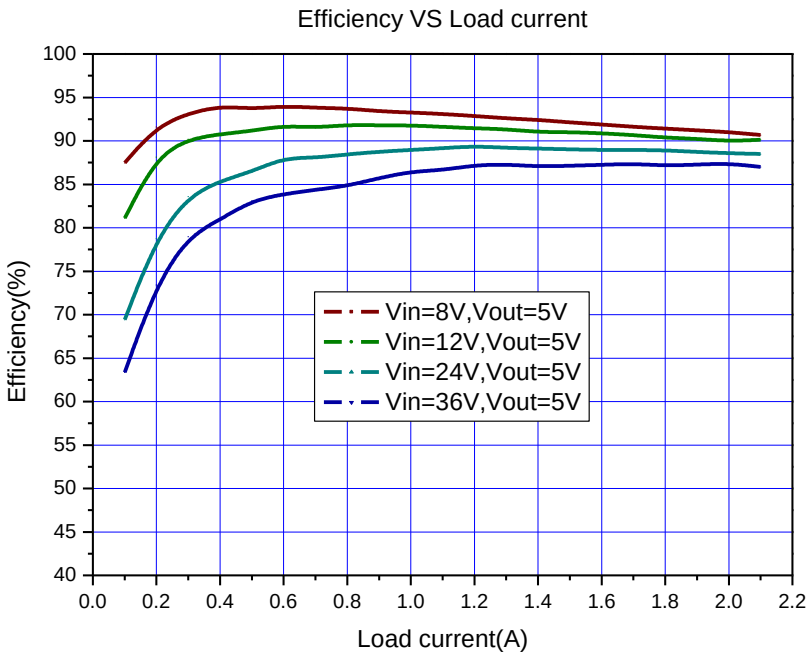


Figure7. XL2011 System Efficiency Curve

Output short shutdown function description

The output short shutdown function is built in XL2011. The short protection circuit monitors the output voltage, whenever FB pin voltage is below 1.5V, the short circuit protection circuit is triggered, the converter will be shutdown, input current less than 5mA.

When the short fault is removed，if output load is floating, then converter will restart up, the output voltage will return to normal; if output load isn’t floating, then converter must be power reset , the output voltage will comeback.

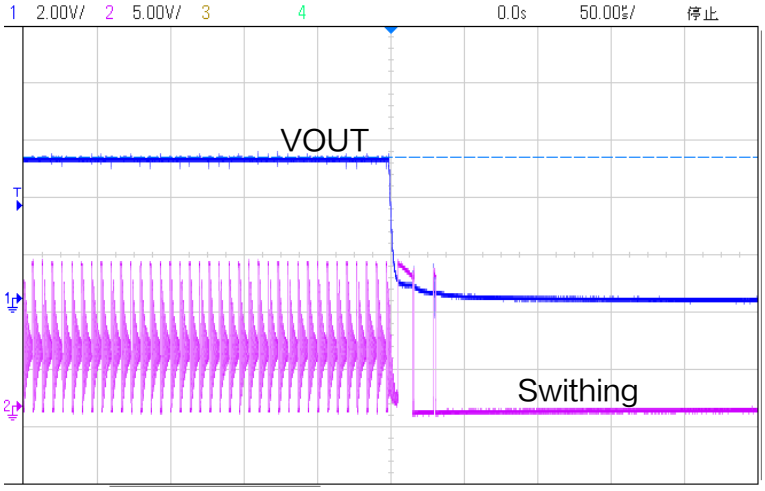


Figure8. The converter will be shutdown when output short happen.

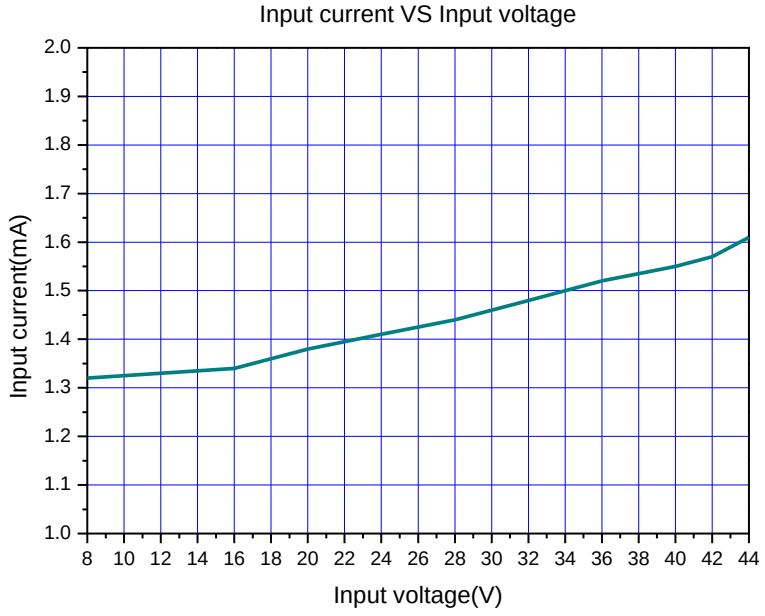
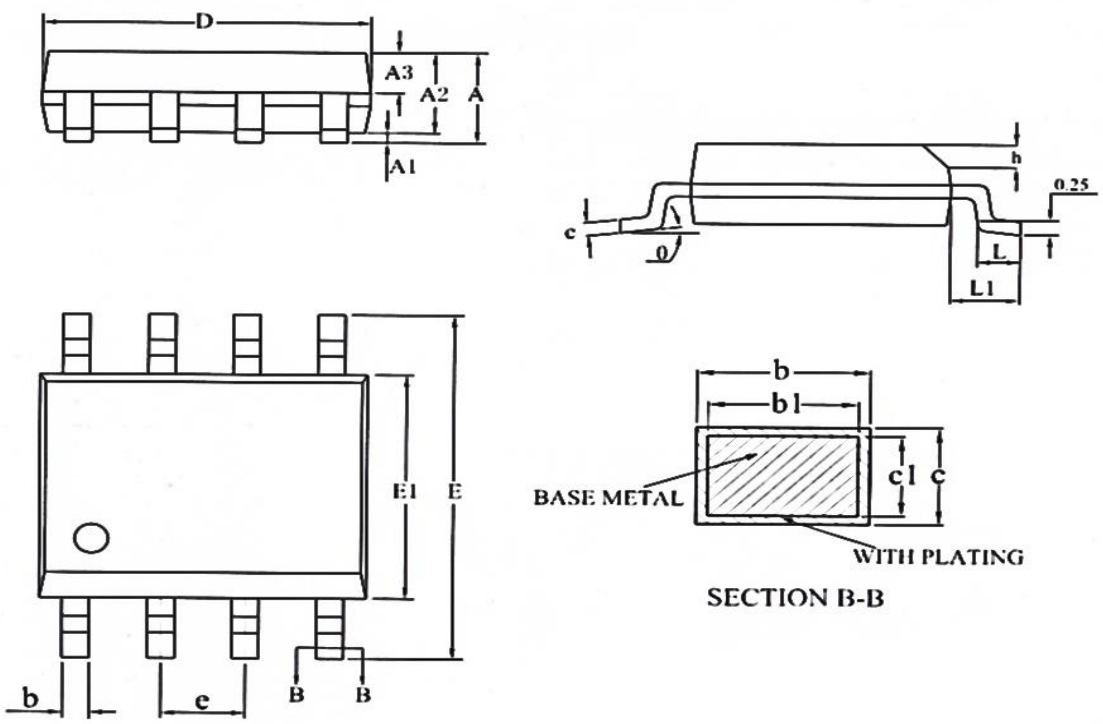


Figure9. The input current curve when output short happen.

Package Information

SOP8



Symbol	Dimensions In Millimeters			Dimensions In Inches		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	1.35	1.55	1.75	0.053	0.061	0.069
A1	0.05	–	0.25	0.002	–	0.010
A2	1.25	1.40	1.65	0.049	0.055	0.065
A3	0.50	0.60	0.70	0.019	0.024	0.028
b	0.30	–	0.51	0.012	–	0.020
b1	0.29	0.41	0.48	0.011	0.016	0.018
c	0.17	–	0.25	0.007	–	0.010
c1	0.17	0.20	0.23	0.007	0.008	0.009
D	4.70	4.90	5.10	0.185	0.193	0.200
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	1.14	1.27	1.40	0.045	0.050	0.055
h	0.25	–	0.50	0.010	–	0.020
L	0.45	–	0.80	0.017	–	0.031
L1	0.82	1.03	1.23	0.032	0.040	0.048
θ	0	–	8°	0	–	8°

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